TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC7SPB9306TU,TC7SPB9307TU

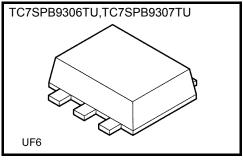
Low Voltage / Low Power 1-Bit Dual Supply Bus Switch

The TC7SPB9306 and TC7SPB9307 are CMOS 1-bit dual-supply bus switches that can provide an interface between two nodes at different voltage levels.

These devices can be connected to two independent power supplies. VCCA supports 1.8-V, 2.5-V and 3.3-V power supplies, whereas VCCB supports 2.5-V, 3.3-V and 5.0-V power supplies.

Bidirectional level-shifting is possible by simply adding external pull-up resistors between the A/B data lines and the V_{CCA}/V_{CCB} supplies. There is no restriction on the relative magnitude of the A and B voltages; both the A and B data lines can be pulled up to arbitrary power supplies.

The enable signal can be used to disable the device so that the buses are effectively isolated.



Weight: 7 mg (typ.)

For the TC7SPB9306, Output Enable (OE) is active-High: When OE is High, the switch is on; when Low, the switch is off. For the TC7SPB9307, Output Enable (\overline{OE}) is active-Low: When \overline{OE} is Low, the switch is on; when High, the switch is off.

The TC7SPB9306 and TC7SP9307 supports power-down protection at the $\overline{\text{OE}}$, OE input, with $\overline{\text{OE}}$, OE being 5.5-V tolerant.

The channels consist of n-type MOSFETs.

All the inputs provide protection against electrostatic discharge.

Features

- Operating voltage:1.8-V to 2.5-V, 1.8-V to 3.3-V, 1.8-V to 5.0-V, 2.5-V to 3.3-V, 2.5-V to 5.0-V or 3.3-V to 5.0-V bidirectional interface
- Operating voltage: $V_{CCA} = 1.65$ to 5.0 V, $V_{CCB} = 2.3$ to 5.5 V
- Low ON-resistance: $Ron = 5.0 \Omega$ (typ.)

(ON-resistance test circuit: $V_{IS} = 0 \text{ V}$, $I_{IS} = 30 \text{ mA}$, $V_{CCA} = 3.0 \text{ V}$, $V_{CCB} = 4.5 \text{ V}$)

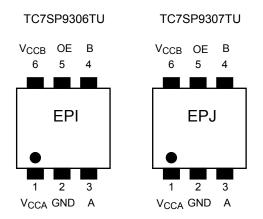
• ESD performance: Machine model $\geq \pm 200 \text{ V}$

Human body model $\geq \pm 2000 \text{ V}$

- 5.5-V tolerance and power-down protection at the Output Enable input.
- · Packages: UF6



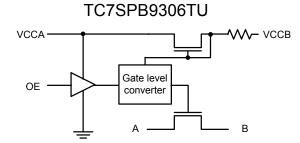
Pin Assignment (top view)

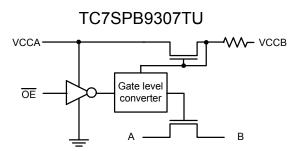


Truth Table

Inputs(9306)	Function	Inputs(9307)	Function	
OE	1 dilodoli	ŌE		
L	Disconnect	L	A port = B port	
Н	A port = B port	Н	Disconnect	

Circuit Schematic







Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V_{CCA}	-0.5 to 7.0	V
l ower supply voltage	V _{CCB}	-0.5 to 7.0	v
Control input voltage	V _{IN}	-0.5 to 7.0	V
Switch input/output voltage	VS	-0.5 to 7.0	٧
Clump diode current	I _{IK}	-50	mA
Switch input/output current	IS	64	mA
DC V _{CC} /ground current per supply pin	ICCA	±25	mA
DC VCC/ground current per supply pin	I _{CCB}	±25	IIIA
Power dissipation	PD	200	mW
Storage temperature	T _{stg}	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit	
Power supply voltage	V _{CCA}	1.65 to 5.0	V	
(Note 2)	V _{CCB}	2.3 to 5.5	V	
Control input voltage	V _{IN}	0 to 5.5	V	
Switch input/output voltage	V _S	0 to 5.5	V	
Operating temperature	T _{opr}	-40 to 85	°C	
Control input rise and fall times	dt/dv	0 to 10	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either V_{CCA} or GND.

Note 2: The V_{CCA} voltage must be lower than the V_{CCB} voltage.



Application Circuit

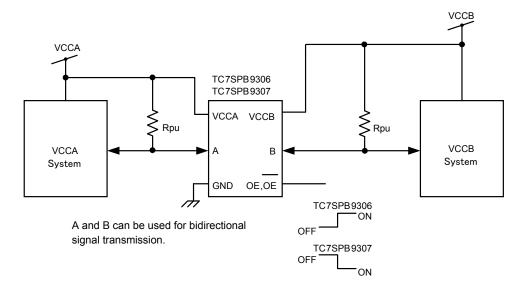


Figure 1 Application Circuit Diagram

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The V_{CCA} voltage must be lower than the V_{CCB} voltage.

Level-shifting functionality is enabled by adding pull-up resistors from A to V_{CCA} or V_{CCB} and from B to V_{CCB} or V_{CCA} , respectively.



Electrical Characteristics

DC Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characte	riotico	Symbol	Test Condition	V (V)	\/aa= (\/)	Ta = -40	to 85°C	Unit	
Characte	TISUCS	Symbol	rest Condition	V _{CCA} (V)	V _{CCB} (V)	Min	Max	Offic	
High-level	Vih —		1.65 ≤ V _{CCA} < 2.3	V _{CCA} to 5.5	0.8× V _{CCA}				
Control input	Tilgii-level	VIП		2.3 ≤ V _{CCA} < 5.0	V _{CCA} to 5.5	0.7× V _{CCA}		V	
voltage	Low-level	VIL	_	1.65 ≤ V _{CCA} < 2.3	V _{CCA} to 5.5	_	0.2× V _{CCA}	V	
	Low-level	VIL	_	2.3 ≤ V _{CCA} < 5.0	V _{CCA} to 5.5	_	0.3× V _{CCA}		
				1.65	2.3	_	16.0		
ON-resistance (Note)	R_{ON} $VI_S = 0V, II_S = 30mA$ $(Figure 2)$	2.3	3.0	_	11.0	Ω			
		(gu. 0 _)	3.0	4.5	_	8.0			
Power off leakage current		l _{OFF}	A, B = 0 to 5.5 V	0	0	_	±1.0	μА	
Switch-off leakage current		I _{SZ}	A, B = 0 to 5.5 V $\overline{OE} = V_L, OE=GND$	1.65 to 5.0	V _{CCA} to 5.5	_	±1.0	μА	
Control input co	urrent	I _{IN}	OE = 0 to 5.5V	1.65 to 5.0	V _{CCA} to 5.5	_	±1.0	μА	
leakage current form V _{CCB} to V _{CCA}		I _{CCBA}	OE = 0 or V _{CCA} V _{CCB} →V _{CCA}	3.3	5.0	_	10.0	μА	
		I _{CCA1}	$\overline{OE} = V_{CCA}$ or GND, I _S =0 A	1.65 to 5.0	V _{CCA}	_	1.0		
Quiescent supp	nly current	I _{CCB1}	$\overline{OE} = V_{CCA}$ or GND, I _S =0 A	1.65 to 5.0	V _{CCA}	_	1.0	^	
Quiescent supp	pry Currerit	I_{CCA2} $V_{CCA} \le \overline{OE} \le 5.5 \text{ V, } I_S=0 \text{ A}$		1.65 to 5.0	V _{CCA}	_	±1.0	μА	
		I _{CCB2}	$V_{CCA} \le \overline{OE} \le 5.5 \text{ V, I}_S=0 \text{ A}$	1.65 to 5.0	V_{CCA}	_	±1.0		

Note: ON-resistance is measured by measuring the voltage drop across the switch at the indicated current.

Level Shift Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characteristics	Symbol	Test Condition	V (V)	\/a== (\/\	Ta = -40	Unit	
Characteristics Symbol		rest Condition	V _{CCA} (V)	V _{CCB} (V)	Min	Max	Offic
Input/Output Characteristics		A = V _{IN}	1.65	3.0 to 5.5	1.4	_	
(Up Translation)	V _{OHU}	SW = ON	2.3	4.5 to 5.5	2.05	_	
(Note 1)		(Figure 7)	3.0	4.5 to 5.5	2.7	_	V
Input/Output Characteristics		A = V _{CCA}	1.65	3.3 to 5.5	1.3	1.65	V
(Down Translation)	V_{OHD}	SW = ON	2.3	4.5 to 5.5	1.95	2.3	
(Note 2)		(Figure 9)	3.0	4.5 to 5.5	2.6	3.0	

Note 1: The Input/Output Characateristics for up translation indicate the input voltages required to provide $V_{CCA} + 0.5 \text{ V}$ on the outputs when measured using the test circuitry shown in Figure 7.

Note 2: The Input/Output Characateristics for down translation indicate the voltages that cause the output voltages to saturate when measured using the test circuitry shown in Figure 9.



AC Characteristics (Ta = -40 to 85°C, Input: $t_r = t_f = 2.0$ ns, f=10 kHz)

 V_{CCA} = 3.3 \pm 0.3 V, V_{CCB} = 5.0 \pm 0.5 V

Characteristics	Symbol	Test Condition		Min	Max	Unit
Propagation delay time (Bus to Bus)	^t pLH	Figures 3 and 5	(Note)	_	0.3	
Propagation delay time (Bus to Bus)	t _{pHL}	Figures 3 and 5	(Note)	_	1.2	ns
Output enable time	t _{pZL}	Figures 4 and 6		_	9.0	
Output disable time	t _{pLZ}	Figures 4 and 6		_	11.0	

Note: This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On resistance of the switch and the 30 pF load capacitance, when driven by an ideal voltage the source (zero output impedance).

 $V_{CCA} {=}~2.5 \pm 0.2~\text{V},~V_{CCB} {=}~5.0 \pm 0.5~\text{V}$

Characteristics	Symbol	Test Condition		Min	Max	Unit
Propagation delay time (Bus to Bus)	^t pLH	Figures 3 and 5	(Note)	_	0.35	
Propagation delay time (Bus to Bus)	t _{pHL}	Figures 3 and 5	(Note)	_	1.8	ns
Output enable time	t _{pZL}	Figures 4 and 6		_	13.0	
Output disable time	t _{pLZ}	Figures 4 and 6		_	15.0	

Note: This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On resistance of the switch and the 30 pF load capacitance, when driven by an ideal voltage the source (zero output impedance).

 $V_{CCA} = 2.5 \pm 0.2$ V, $V_{CCB} = 3.3 \pm 0.3$ V

Characteristics	Symbol	Test Condition	Min	Max	Unit
Propagation delay time (Bus to Bus)	^t pLH	Figures 3 and 5 (Note)	_	0.45	
Propagation delay time (Bus to Bus)	t _{pHL}	Figures 3 and 5 (Note)	_	2.2	ns
Output enable time	t _{pZL}	Figures 4 and 6	_	17.0	
Output disable time	t _{pLZ}	Figures 4 and 6	_	19.0	

Note: This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On resistance of the switch and the 30 pF load capacitance, when driven by an ideal voltage the source (zero output impedance).

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition		_	Тур.	Unit
Characteristics	Syllibol	rest Condition	V _{CCA} (V)	V _{CCB} (V)		Offic
Control input capacitance	C _{IN}		3.3	3.3	3	
Switch input/output capacitance	Cuo	SW=ON	3.3	3.3	14	pF
	C _{I/O}	SW=OFF	3.3	3.3	7	

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DC Test Circuit

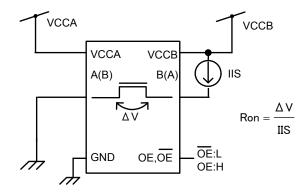


Figure 2 ON-resistance Test Circuit

AC Test Circuits

• tpLH,HL

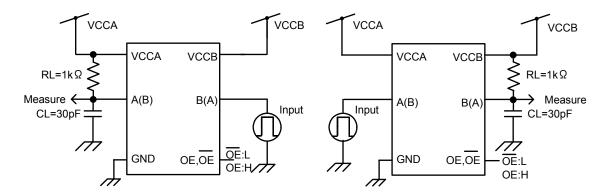


Figure 3 tpLH, tpHL Test Circuits

• tpLZ,ZL

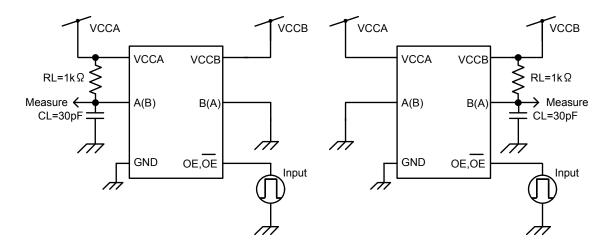


Figure 4 tpLZ, tpZL Test Circuits

AC Waveform

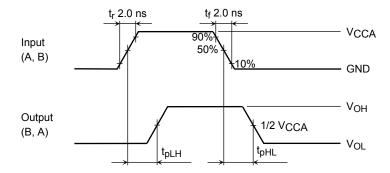


Figure 5 tpLH, tpHL

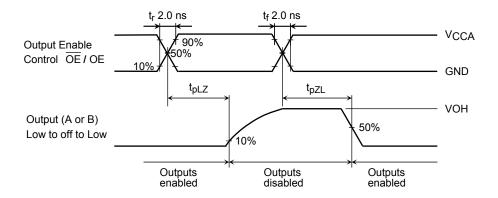


Figure 6 tpLZ, tpZL

Level Shift Function (Used Pull-up Resistance)

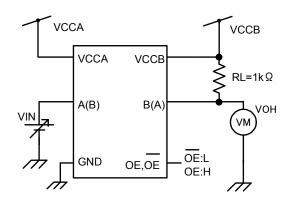
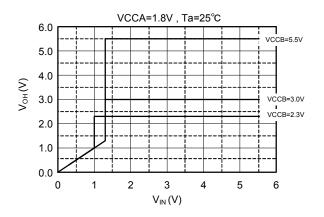
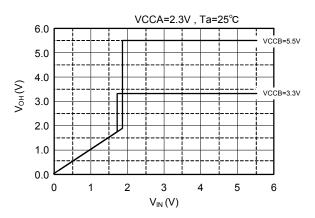


Figure 7 Test Circuit





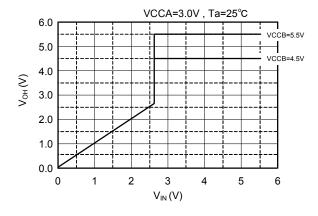


Figure 8 Input/Output Characteristics (Typ.)

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Level Shift Function (Unused Pull-up Resistance)

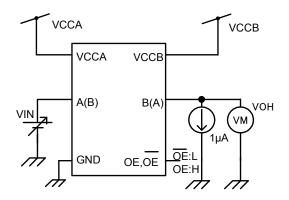


Figure 9 Test Circuits

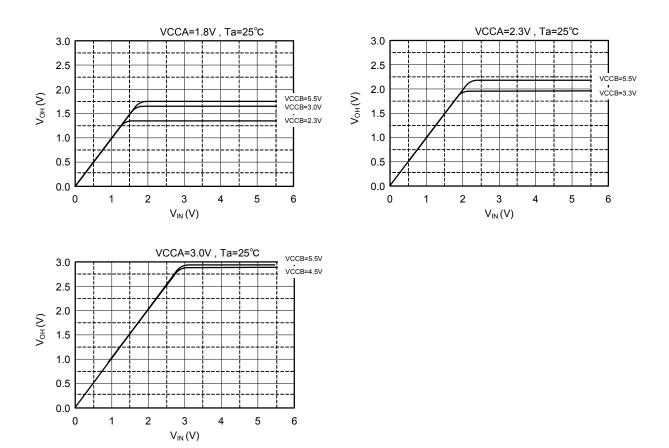
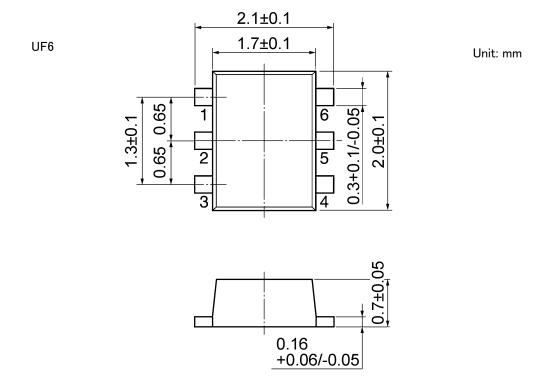


Figure 10 Input/Output Characteristics (Typ.)

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Package Dimensions



Weight: 7 mg (typ.)

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